

PIC18F65/66K40 Family Silicon Errata and Data Sheet Clarification

The PIC18F65/66K40 family devices that you have received conform functionally to the current Device Data Sheet (DS40001842B), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).


The errata described in this document will be addressed in future revisions of the PIC18F65/66K40 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A4**).

Data Sheet clarifications and corrections start on [page 6](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
 - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ().
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC18F65/66K40 silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

Part Number	DEVICE ID<13:0> ^{(1),(2)}	Revision ID for Silicon Revision	
		A3	A4
PIC18F65K40	6B00h	A003	A004
PIC18LF65K40	6B60h	A003	A004
PIC18F66K40	6AE0h	A003	A004
PIC18LF66K40	6B40h	A003	A004

- Note 1:** The Device ID is located in addresses 3FFFFCh-3FFFFDh and 3FFFFEh-3FFFFFh.
- 2:** Refer to the “*PIC18(L)F6xK40 Memory Programming Specification*” (DS40001822) for detailed information on Device and Revision IDs for your specific device.

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TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item No.	Issue Summary	Affected Revisions ⁽¹⁾	
				A3	A4
Analog-to-Digital Converter (ADC)	ADC Conversion	1.1	Delay of one instruction cycle required prior to setting the ADGO bit when using ADCRC as the ADCC clock source.	X	
Analog-to-Digital Converter (ADC)	Computation Overflow Bit	1.2	The Computation Overflow bit may be erroneously set by the ADFLTR.	X	
Analog-to-Digital Converter (ADC)	ADCR Oscillator Operation in Sleep	1.3	The ADCRC oscillator does not stop after conversion is complete in Sleep mode.	X	X
Analog-to-Digital Converter (ADC)	ADC Conversion with FVR	1.4	Using the FVR as the ADC positive voltage reference can cause missing codes.	X	X
PIC18 Debug Executive	Data Write Match Breakpoints	2.1	Data write match breakpoints do not work when used on a location GPR space.	X	
PIC18 Core	TBLRD	3.1	TBLRD requires NVMREG value to point to appropriate memory.	X	
Program Flash Memory	Endurance of PFM Cell	4.1	Endurance of the PFM cell is lower than specified.	X	X
MSSP	SMBus 2.0 Voltage Level	5.1	Input low voltage threshold level is dependent on VDD.	X	X
Electrical Specifications for LF Devices Only	Min VDD Specification	6.1	VDDMIN specifications are changed for LF devices only at -40°C and 0°C.		X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A4**).

1. Module: Analog-to-Digital Converter (ADC)

1.1 ADC Conversion

When using the ADCRC as the clock source for ADCC, there is a delay of one instruction cycle between the user setting the ADGO bit and being able to read it set. This can lead to a false conversion complete scenario (i.e., ADGO being cleared), depending if the user code has a bit clear test (BTFSC instruction on the ADGO bit, immediately after setting the ADGO bit. See code example below.

e.g.

```
BSF ADCON0, ADGO ; Start conversion
BTSFC ADCON0, ADGO ; Is conversion done?
GOTO $-1 ; No, test again
```

The BTFSC will pass the very first time in this situation.

Work around

Add a NOP instruction after setting the ADGO bit and before testing the bit for completion of conversion. See code example below.

e.g.

```
BSF ADCON0, ADGO ; Start conversion
NOP
BTSFC ADCON0, ADGO ; Is conversion done?
GOTO $-1 ; No, test again
```

Affected Silicon Revisions

A3	A4						
X							

1.2 Computation Overflow Bit

If the sign bit of ADFLTR (bit 7 of ADFLTRH) is set, the Computation Overflow bit will also be set, even though this is not a legitimate case of an overflow event.

Work around

None.

Affected Silicon Revisions

A3	A4						
X							

1.3 ADCRC Oscillator Operation in Sleep

If the part is in Sleep and the ADCRC oscillator is used as the clock source to the ADC, the oscillator continues to run after the conversion is complete. This will increase the current consumption in Sleep mode. The oscillator will stop after the device exits Sleep mode and resumes normal code execution.

Work around

None.

Affected Silicon Revisions

A3	A4						
X	X						

1.4 ADC Conversion with FVR

Using the FVR as the positive voltage reference for the ADC can cause an increase in missing codes.

Work around

Increase the bit conversion time, known as TAD, to 8 μ s or higher.

Affected Silicon Revisions

A3	A4						
X	X						

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2. Module: PIC18 Debug Executive

2.1 Data Write Match Breakpoints

If the data in a GPR location is modified using any arithmetic instruction like `INCF`, `ADDWF`, `SETF`, `CLRF`, etc., the data write match breakpoint does not work. It works with `MOVE`, which moves the data into the same memory location.

e.g.

1.

```
MOVLB    0x00
CLRF     0x08
LOOP
INCF     0x08 ;Doesn't break when data
              breakpoint set @ 0x08
              with data match for 0xAA

GOTO     LOOP
```

2.

```
MOVLB    0x00
MOVLW   0xAA
MOVF     0x08 ;Breaks when data
              breakpoint set @ 0x08
              with data match for 0xAA
```

Work around

Use data write breakpoints without matching wherever possible.

Affected Silicon Revisions

A3	A4						
X							

3. Module: PIC18 Core

3.1 TBLRD requires NVMREG value to point to appropriate memory

The affected silicon revisions of the PIC18FXXK40 devices improperly require the `NVMREG<1:0>` bits in the `NVMCON` register to be set for `TBLRD` access of the various memory regions. The issue is most apparent in compiled C programs when the user defines a `const` type and the compiler uses `TBLRD` instructions to retrieve the data from program Flash memory (PFM). The issue is also apparent when the user defines an array in RAM for which the compiler creates start-up code, executed before `main()`, that uses `TBLRD` instructions to initialize RAM from PFM.

Work around

Assembly code:

Set the `NVMREG<1:0>` bits to select the appropriate memory region before executing `TBLRD` instructions.

C code:

Create an assembly file named `powerup.as` and include this file with the other files in the project. This file will change the `NVMREG<1:0>` bits to point to program Flash before any code is executed.

Contents of the `powerup.as` file:

```
#include <xc.inc>
GLOBAL powerup, start
PSECT powerup, class=CODE, delta=1,
      reloc=2

powerup:
    BSF    NVMCON1, 7
    GOTO   start
end
```

If there is a need to change the `NVMREG<1:0>` value to anything other than '10' and the Interrupt Service Routine uses constants or literal strings, then interrupts must be disabled before the change and restored to '10' before interrupts are enabled.

Affected Silicon Revisions

A3	A4						
X							

4. Module: Program Flash Memory

4.1 Endurance of PFM is Lower than Specified

The Flash memory cell endurance specification (Parameter `MEM30`) is 1K cycles.

Work around

None.

Affected Silicon Revisions

A3	A4						
X	X						

5. Module: MSSP

5.1 SMBus 2.0 Voltage Level

The input low-voltage threshold level (V_{IL}) depends on `VDD`, as follows:

$V_{IL} = 0.7$ for $VDD < 4V$

$V_{IL} = 0.8$ for $VDD > 4V$

Work around

None.

Affected Silicon Revisions

A3	A4						
X	X						

6. Module: Electrical Specifications for LF Devices Only

6.1 Min VDD Specification

VDDMIN specifications are changed for LF devices only.

VDDMIN at -40°C to 0°C = 2.3V

VDDMIN at 0°C to 25°C = 2.1V

Work around

None.

Affected Silicon Revisions

A3	A4							
	X							

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Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001842B):

None.

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (09/2016)

Initial release of this document.

Rev B Document (12/2016)

Added modules 1.3. ADCRC Oscillator Operation in Sleep, 1.4. ADC Conversion with FVR, and 5. MSSP to the Silicon Errata Issues section. Other minor corrections.

Rev C Document (3/2017)

Added Module 6 to Silicon Errata Issues; other minor corrections.

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NOTES:

Note the following details of the code protection feature on Microchip devices:

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- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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